

### 2.0x1.25mm INFRARED EMITTING DIODE

Part Number: AP2012SF4C

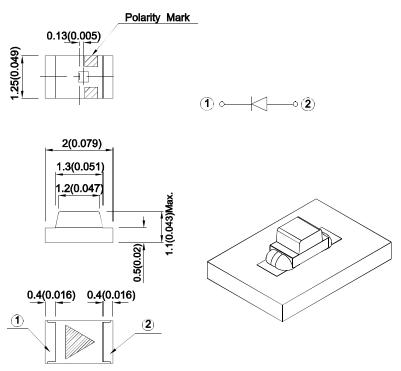
### **Features**

- 2.0mmx1.25mm SMD LED,1.1mm thickness.
- Mechanically and spectrally matched to the phototransistor.
- Package: 2000pcs / reel.
- Moisture sensitivity level : level 3.
- RoHS compliant.

### Description

SF4 Made with Gallium Aluminum Arsenide Infrared Emitting diodes.

### **Package Dimensions**



- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is  $\pm 0.1(0.004")$  unless otherwise noted.
- The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.
   The device has a single mounting surface. The device must be mounted according to the specifications.

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### **Selection Guide**

Part No.	Emitting Color (Material)	Lens Type	Po (mW/sr) [2] @ 20mA		Viewing Angle [1]
		2.	Min.	Тур.	201/2
AP2012SF4C	Infrared (GaAlAs)	Water Clear	0.8	1.5	160°

- 1.  $\theta$ 1/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.
- 2. Radiant intensity / luminous Flux: +/-15%.
- 3. Radiant intensity value is traceable to CIE127-2007 standards.

### Electrical / Optical Characteristics at TA=25°C

Parameter	P/N	Symbol	Тур.	Max.	Units	Test Conditions	
Forward Voltage [1]	SF4	VF	1.3	1.6	V	IF=20mA	
Reverse Current	SF4	lR		10	uA	VR = 5V	
Capacitance	SF4	С	90		pF	VF=0V;f=1MHz	
Peak Spectral Wavelength	SF4	λP	880		nm	I=20mA	
Spectral Bandwidth	SF4	Δλ1/2	50		nm	IF=20mA	

### Notes:

- 1. Forward Voltage: + / -0.1V.
- 2. Wavelength value is traceable to CIE127-2007 standards.
- 3. Excess driving current and / or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

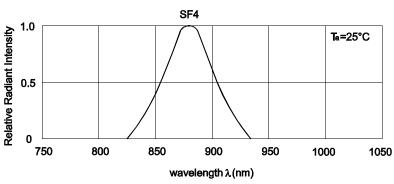
### Absolute Maximum Ratings at TA=25°C

Absolute maximum Rutings at 1A 25 5						
Parameter	Symbol	Values	Units			
Power dissipation	Po	80	mW			
DC Forward Current	lF	50	mA			
Peak Forward Current [1]	İFS	1.2	А			
Reverse Voltage	VR	5	V			
Operating Temperature	Та	-40 To +85	°C			
Storage Temperature	Тѕтс	-40 To +85 °C				

- Note: 1. 1/10 Duty Cycle, 0.1ms Pulse Width.
- 2. Relative humidity levels maintained between 40% and 60% in production area are recommended to avoid the build-up of static electricity Ref JEDEC/JESD625-A and JEDEC/J-STD-033.

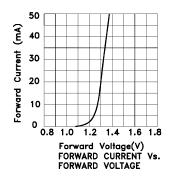
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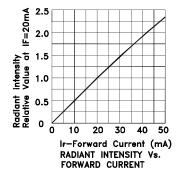
## **Kingbright**

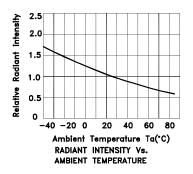


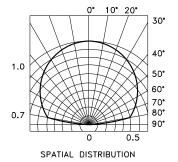
Relative Intensity Vs. Wavelength

### AP2012SF4C









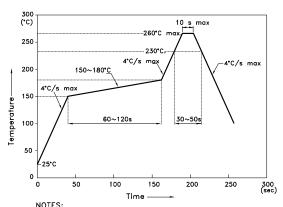
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### **AP2012SF4C**

Reflow soldering is recommended and the soldering profile is shown below. Other soldering methods are not recommended as they might cause damage to the product.

Reflow Soldering Profile For Lead-free SMT Process.



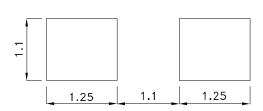
- NOTES:

  1.We recommend the reflow temperature 245°C(+/-5°C). The maximum soldering temperature should be limited to 260°C.

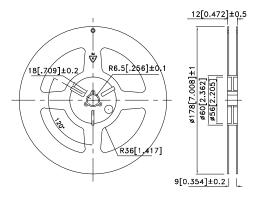
  2.Don't cause stress to the epoxy resin while it is exposed to high temperature.
  - to high temperature.

    3.Number of reflow process shall be 2 times or less.

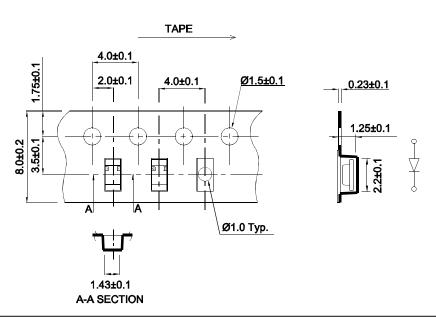
## Recommended Soldering Pattern (Units: mm; Tolerance: ± 0.1)



### **Reel Dimension**



Tape Specifications (Units: mm)

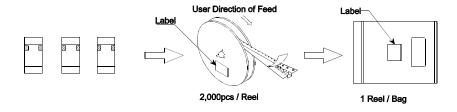


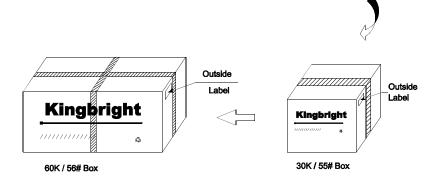
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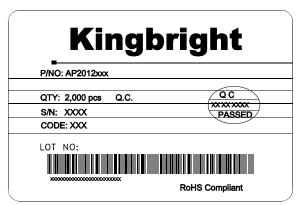
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### **PACKING & LABEL SPECIFICATIONS**

### **AP2012SF4C**







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